

STTH1212

Ultrafast recovery - 1200 V diode

Main product characteristics

| I _{F(AV)} | 12 A |
|-----------------------|--------|
| V_{RRM} | 1200 V |
| T _j | 175° C |
| V _F (typ) | 1.25 V |
| t _{rr} (typ) | 50 ns |

Features and benefits

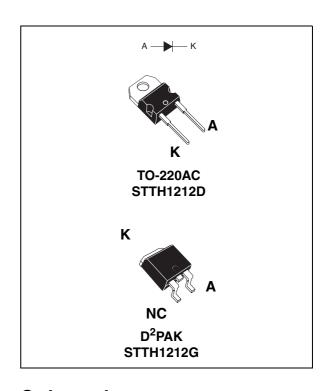
- Ultrafast, soft recovery
- Very low conduction and switching losses
- High frequency and/or high pulsed current operation
- High reverse voltage capability
- High junction temperature

Description

The high quality design of this diode has produced a device with low leakage current, regularly reproducible characteristics and intrinsic ruggedness. These characteristics make it ideal for heavy duty applications that demand long term reliability.

Such demanding applications include industrial power supplies, motor control, and similar mission-critical systems that require rectification and freewheeling. These diodes also fit into auxiliary functions such as snubber, bootstrap, and demagnetization applications.

The improved performance in low leakage current, and therefore thermal runaway guard band, is an immediate competitive advantage for this device.



Order codes

| Part Number | Marking |
|--------------|-----------|
| STTH1212D | STTH1212D |
| STTH1212G | STTH1212G |
| STTH1212G-TR | STTH1212G |

Characteristics STTH1212

Characteristics 1

Table 1. Absolute ratings (limiting values at 25° C, unless otherwise specified)

| Symbol | Paramo | Value | Unit | | |
|---------------------|---|--|------|--------------|----|
| V _{RRM} | Repetitive peak reverse voltage | Repetitive peak reverse voltage | | | V |
| I _{F(RMS)} | RMS forward current | | | 30 | Α |
| I _{F(AV)} | Average forward current, $\delta = 0.5$ $T_c = 130^{\circ} C$ | | | 12 | Α |
| I _{FRM} | Repetitive peak forward current | Repetitive peak forward current $t_p = 5 \mu s$, $F = 5 kHz square$ | | | Α |
| I _{FSM} | Surge non repetitive forward current $t_p = 10$ ms Sinusoidal | | | 100 | Α |
| T _{stg} | Storage temperature range | | | -65 to + 175 | °C |
| T _j | Maximum operating junction temperature |) | | 175 | °C |

Table 2. Thermal parameter

| Symbol | Parameter | Value | Unit |
|----------------------|------------------|-------|------|
| R _{th(j-c)} | Junction to case | 1.6 | °C/W |

Static electrical characteristics Table 3.

| Symbol | Parameter | Test conditions | | Min. | Тур | Max. | Unit |
|-------------------------------|---|-------------------------|-----------------------|------|------|------|------|
| I _B ⁽¹⁾ | Poverse leekage aurrent | T _j = 25° C | V -V | | | 10 | |
| R`′ | $I_{R}^{(1)}$ Reverse leakage current $T_{j} = 125^{\circ} \text{ C}$ $V_{R} = V_{R}^{(1)}$ | $V_R = V_{RRM}$ | | 7 | 70 | μΑ | |
| | | T _j = 25° C | | | | 2.2 | |
| V _F ⁽²⁾ | Forward voltage drop | T _j = 125° C | I _F = 12 A | | 1.30 | 2.0 | V |
| | | T _j = 150° C | | | 1.25 | 1.9 | |

^{1.} Pulse test: t_p = 5 ms, δ < 2 %

To evaluate the conduction losses use the following equation: P = 1.5 x $I_{F(AV)}$ + 0.033 $I_{F}^{2}_{(RMS)}$

$$P = 1.5 \times I_{E(AV)} + 0.033 I_{E}^{2} (RMS)$$

^{2.} Pulse test: t_p = 380 μ s, δ < 2 %

STTH1212 Characteristics

Table 4. Dynamic characteristics

| Symbol | Parameter | Test conditions | Min. | Тур | Max. | Unit |
|-----------------|--------------------------|---|------|-----|------|------|
| + | | $I_F = 1 \text{ A, } dI_F/dt = -50 \text{ A/}\mu\text{s,}$ $V_R = 30 \text{ V, } T_j = 25^{\circ} \text{ C}$ | | | 100 | ns |
| t _{rr} | Reverse recovery time | $I_F = 1 \text{ A, } dI_F/dt = -100 \text{ A/}\mu\text{s,}$ $V_R = 30 \text{ V, } T_j = 25^{\circ} \text{ C}$ | | 50 | 70 | 115 |
| I _{RM} | Reverse recovery current | $I_F = 12 \text{ A}, dI_F/dt = -200 \text{ A/}\mu\text{s}, \ V_R = 600 \text{ V}, T_j = 125^{\circ} \text{ C}$ | | 16 | 24 | Α |
| S | Softness factor | $I_F = 12 \text{ A}, dI_F/dt = -200 \text{ A/}\mu\text{s}, \ V_R = 600 \text{ V}, T_j = 125^{\circ} \text{ C}$ | | 2 | | |
| t _{fr} | Forward recovery time | $I_F = 12 \text{ A}$ $dI_F/dt = 50 \text{ A/}\mu\text{s}$ $V_{FR} = 1.5 \text{ x } V_{Fmax}, T_j = 25^{\circ} \text{ C}$ | | | 400 | ns |
| V _{FP} | Forward recovery voltage | $I_F = 12 \text{ A}, \text{ d}I_F/\text{d}t = 50 \text{ A/}\mu\text{s},$ $T_j = 25^{\circ} \text{ C}$ | | 6 | | ٧ |

Figure 1. Conduction losses versus average current

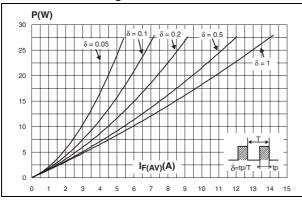
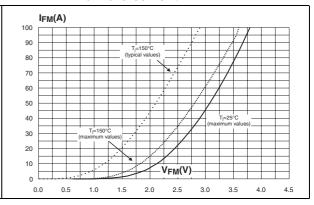


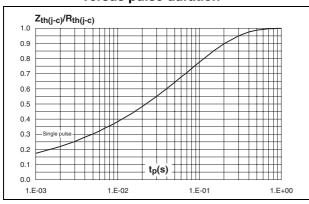
Figure 2. Forward voltage drop versus forward current



Characteristics STTH1212

Figure 3. Relative variation of thermal impedance junction to case versus pulse duration

Figure 4. Peak reverse recovery current versus dl_F/dt (typical values)



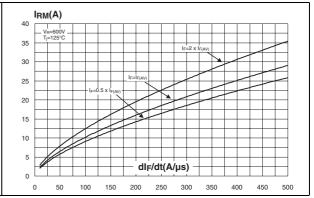
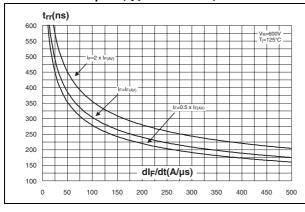


Figure 5. Reverse recovery time versus dl_F/dt (typical values)

Figure 6. Reverse recovery charges versus dl_F/dt (typical values)



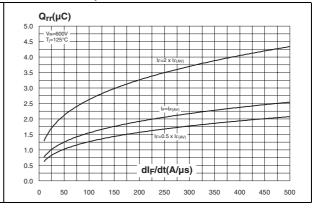
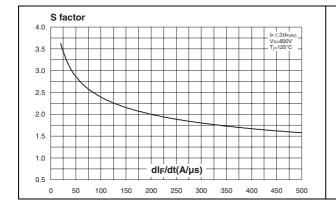
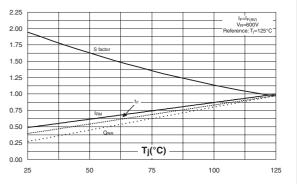


Figure 7. Softness factor versus dl_F/dt (typical values)

Figure 8. Relative variations of dynamic parameters versus junction temperature

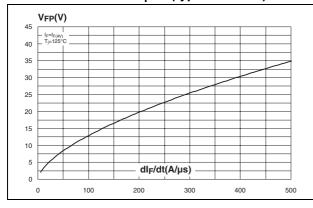




STTH1212 Characteristics

Figure 9. Transient peak forward voltage versus dl_F/dt (typical values)

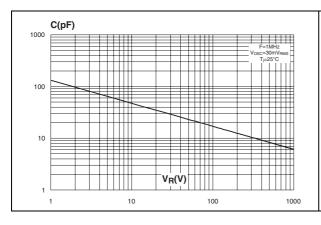
Figure 10. Forward recovery time versus dl_F/dt (typical values)

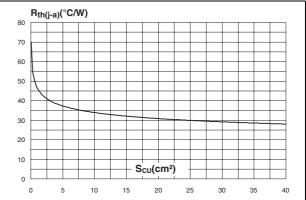


t_{fr}(ns) dlf/dt(A/µs)

Figure 11. Junction capacitance versus reverse voltage applied (typical values)

Figure 12. Thermal resistance junction to ambient versus copper surface under tab (Epoxy printed circuit board FR4, e_{cu} = 35 μ m)





2 Package mechanical data

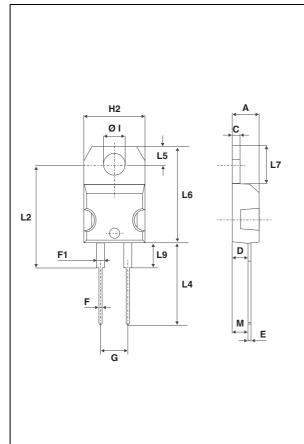
Epoxy meets UL94, V0

Cooling method: by conduction (C)

Recommended torque value: 0.55 Nm (TO-220AC)

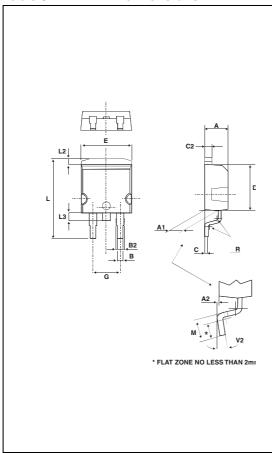
Maximum torque value: 0.7 Nm (TO-220AC)

Table 5. T0-220AC dimensions



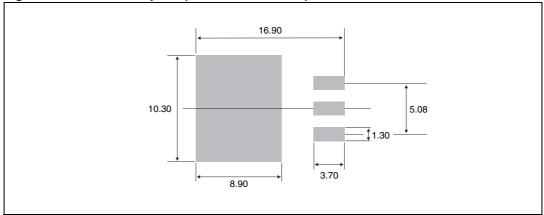
| | | DIMEN | ISIONS | | |
|---------|-------------|------------|------------|--------|--|
| REF. | Millimeters | | Inches | | |
| | Min. | Max. | Min. | Max. | |
| Α | 4.40 | 4.60 | 0.173 | 0.181 | |
| С | 1.23 | 1.32 | 0.048 | 0.051 | |
| D | 2.40 | 2.72 | 0.094 | 0.107 | |
| Е | 0.49 | 0.70 | 0.019 | 0.027 | |
| F | 0.61 | 0.88 | 0.024 | 0.034 | |
| F1 | 1.14 | 1.70 | 0.044 | 0.066 | |
| G | 4.95 | 5.15 | 0.194 | 0.202 | |
| H2 | 10.00 | 0.00 10.40 | | 0.409 | |
| L2 | 16.40 | 0 typ. | 0.645 typ. | | |
| L4 | 13.00 | 14.00 | 0.511 | 0.551 | |
| L5 | 2.65 | 2.95 | 0.104 | 0.116 | |
| L6 | 15.25 | 15.75 | 0.600 | 0.620 | |
| L7 | 6.20 | 6.60 | 0.244 | 0.259 | |
| L9 | 3.50 | 3.93 | 0.137 | 0.154 | |
| М | 2.6 typ. | | 0.10 | 2 typ. | |
| Diam. I | 3.75 | 3.85 | 0.147 | 0.151 | |

Table 6. D²PAK dimensions



| | DIMENSIONS | | | | |
|------|------------|--------|-------|--------|--|
| REF. | Millim | neters | Inc | hes | |
| | Min. | Max | Min. | Max. | |
| Α | 4.40 | 4.60 | 0.173 | 0.181 | |
| A1 | 2.49 | 2.69 | 0.098 | 0.106 | |
| A2 | 0.03 | 0.23 | 0.001 | 0.009 | |
| В | 0.70 | 0.93 | 0.027 | 0.037 | |
| B2 | 1.14 | 1.70 | 0.045 | 0.067 | |
| С | 0.45 | 0.60 | 0.017 | 0.024 | |
| C2 | 1.23 | 1.36 | 0.048 | 0.054 | |
| D | 8.95 | 9.35 | 0.352 | 0.368 | |
| Е | 10.00 | 10.40 | 0.393 | 0.409 | |
| G | 4.88 | 5.28 | 0.192 | 0.208 | |
| L | 15.00 | 15.85 | 0.590 | 0.624 | |
| L2 | 1.27 | 1.40 | 0.050 | 0.055 | |
| L3 | 1.40 | 1.75 | 0.055 | 0.069 | |
| М | 2.40 | 3.20 | 0.094 | 0.126 | |
| R | 0.40 typ. | | 0.016 | 6 typ. | |
| V2 | 0° | 8° | 0° | 8° | |

Figure 13. D²PAK footprint (dimensions in mm)



In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect . The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com.

Ordering information STTH1212

3 Ordering information

| Part Number | Marking | Package | Weight | Base qty | Delivery mode |
|--------------|-----------|--------------------|--------|----------|---------------|
| STTH1212D | STTH1212D | TO-220AC | 1.86 g | 50 | Tube |
| STTH1212G | STTH1212G | D ² PAK | 1.48 g | 50 | Tube |
| STTH1212G-TR | STTH1212G | D ² PAK | 1.48 g | 1000 | Tape & reel |

4 Revision history

| Date | Revision | Description of Changes |
|-------------|----------|------------------------|
| 02-Mar-2006 | 1 | First issue. |

Please Read Carefully:

Information in this document is provided solely in connection with ST products. STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, modifications or improvements, to this document, and the products and services described herein at any time, without notice.

All ST products are sold pursuant to ST's terms and conditions of sale.

Purchasers are solely responsible for the choice, selection and use of the ST products and services described herein, and ST assumes no liability whatsoever relating to the choice, selection or use of the ST products and services described herein.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted under this document. If any part of this document refers to any third party products or services it shall not be deemed a license grant by ST for the use of such third party products or services, or any intellectual property contained therein or considered as a warranty covering the use in any manner whatsoever of such third party products or services or any intellectual property contained therein.

UNLESS OTHERWISE SET FORTH IN ST'S TERMS AND CONDITIONS OF SALE ST DISCLAIMS ANY EXPRESS OR IMPLIED WARRANTY WITH RESPECT TO THE USE AND/OR SALE OF ST PRODUCTS INCLUDING WITHOUT LIMITATION IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION), OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT.

UNLESS EXPRESSLY APPROVED IN WRITING BY AN AUTHORIZE REPRESENTATIVE OF ST, ST PRODUCTS ARE NOT DESIGNED, AUTHORIZED OR WARRANTED FOR USE IN MILITARY, AIR CRAFT, SPACE, LIFE SAVING, OR LIFE SUSTAINING APPLICATIONS, NOR IN PRODUCTS OR SYSTEMS, WHERE FAILURE OR MALFUNCTION MAY RESULT IN PERSONAL INJURY, DEATH, OR SEVERE PROPERTY OR ENVIRONMENTAL DAMAGE.

Resale of ST products with provisions different from the statements and/or technical features set forth in this document shall immediately void any warranty granted by ST for the ST product or service described herein and shall not create or extend in any manner whatsoever, any liability of ST.

ST and the ST logo are trademarks or registered trademarks of ST in various countries.

Information in this document supersedes and replaces all information previously supplied.

The ST logo is a registered trademark of STMicroelectronics. All other names are the property of their respective owners.

© 2006 STMicroelectronics - All rights reserved

STMicroelectronics group of companies

Australia - Belgium - Brazil - Canada - China - Czech Republic - Finland - France - Germany - Hong Kong - India - Israel - Italy - Japan - Malaysia - Malta - Morocco - Singapore - Spain - Sweden - Switzerland - United Kingdom - United States of America

www.st.com



X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Rectifiers category:

Click to view products by STMicroelectronics manufacturer:

Other Similar products are found below:

70HFR40 RL252-TP 150KR30A 1N5397 NTE5841 NTE6038 SCF5000 1N4002G 1N4005-TR JANS1N6640US 481235F

RRE02VS6SGTR 067907F MS306 70HF40 T85HFL60S02 VS-88-4031 VS-66-9903 US2JFL-TP A1N5404G-G CRS04(T5L,TEMQ)

ACGRA4007-HF ACGRB207-HF CLH03(TE16L,Q) ACGRC307-HF ACEFC304-HF NTE6356 NTE6359 NTE6002 NTE6023 NTE6039

NTE6077 85HFR60 40HFR60 70HF120 85HFR80 D126A45C SCF7500 D251N08B SCHJ22.5K SM100 SCPA2 SCH10000 SDHD5K

VS-12FL100S10 ACGRA4001-HF D1821SH45T PR D1251S45T NTE5990 NTE6358